

英飞凌 CoolSiC™ 混合单管 - TRENCHSTOP™ 5 S5 IGBT

与全额定值第六代 CoolSiC™ 二极管共同封装

特性

- $V_{CE} = 650\text{ V}$
- $I_C = 75\text{ A}$
- TRENCHSTOP™ 5 与 CoolSiC™ 技术相结合，实现超低开关损耗
- 导通损耗非常低
- 硬开关拓扑中的基准效率
- 即插即用，替代纯硅器件
- 最高结温  $T_{vjmax} = 175^{\circ}\text{C}$
- 符合 JEDEC 目标应用要求
- 无铅镀层；符合 RoHS 标准
- 完整的产品品类和 PSpice 模型：<http://www.infineon.com/igbt/>

潜在应用

- 工业开关电源
- 工业级不间断电源（UPS）
- 光伏组串逆变器
- 储能
- 充电器

产品验证

- 根据 JEDEC20/22 相关测试的测试条件，符合上述应用要求

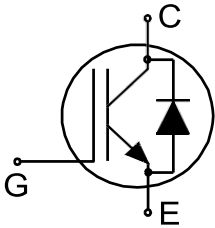
描述

封装引脚定义：

- 引脚 G - 栅极
- 引脚 C & 背面 - 集电极
- 引脚 E - 发射极



- Lead-free
- Green
- Halogen-free
- RoHS



| Type        | Package    | Marking |
|-------------|------------|---------|
| IKW75N65SS5 | PG-TO247-3 | K75ESS5 |

本数据手册的原文使用英文撰写。为方便起见，英飞凌提供了译文；由于翻译过程中可能使用了自动化工具，英飞凌不保证译文的准确性。为确认准确性请务必访问 [infineon.com](http://infineon.com) 参考最新的英文版本（控制文档）。



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1封装

## 1 封装

表 1 特征值

| Parameter                                                       | Symbol        | Note or test condition                               | Values |      |      | Unit |
|-----------------------------------------------------------------|---------------|------------------------------------------------------|--------|------|------|------|
|                                                                 |               |                                                      | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | $L_E$         |                                                      |        | 13.0 |      | nH   |
| Storage temperature                                             | $T_{stg}$     |                                                      | -55    |      | 150  | °C   |
| Soldering temperature                                           |               | wave soldering 1.6 mm (0.063 in.) from case for 10 s |        |      | 260  | °C   |
| Mounting torque                                                 | $M$           | M3 screw Maximum of mounting process: 3              |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                            | $R_{th(j-a)}$ |                                                      |        |      | 40   | K/W  |

## 2 IGBT

表2 最大额定值

| Parameter                                              | Symbol       | Note or test condition                                                                  |                       | Values   | Unit |
|--------------------------------------------------------|--------------|-----------------------------------------------------------------------------------------|-----------------------|----------|------|
| Collector-emitter voltage                              | $V_{CE}$     | $T_{vj} \geq 25\text{ °C}$                                                              |                       | 650      | V    |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        | limited by bondwire                                                                     | $T_c = 25\text{ °C}$  | 80       | A    |
|                                                        |              |                                                                                         | $T_c = 100\text{ °C}$ | 80       |      |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |                                                                                         |                       | 300      | A    |
| Turn-off safe operating area                           |              | $V_{CE} \leq 650\text{ V}$ , $t_p = 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$ |                       | 300      | A    |
| Gate-emitter voltage                                   | $V_{GE}$     |                                                                                         |                       | $\pm 20$ | V    |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p \leq 10\text{ }\mu\text{s}$ , $D < 0.01$                                           |                       | $\pm 30$ | V    |
| Power dissipation                                      | $P_{tot}$    |                                                                                         | $T_c = 25\text{ °C}$  | 395      | W    |
|                                                        |              |                                                                                         | $T_c = 100\text{ °C}$ | 197      |      |

表3 特征值

| Parameter                            | Symbol      | Note or test condition                       |                          | Values |      |      | Unit |
|--------------------------------------|-------------|----------------------------------------------|--------------------------|--------|------|------|------|
|                                      |             |                                              |                          | Min.   | Typ. | Max. |      |
| Collector-emitter saturation voltage | $V_{CEsat}$ | $I_C = 75\text{ A}$ , $V_{GE} = 15\text{ V}$ | $T_{vj} = 25\text{ °C}$  |        | 1.35 | 1.7  | V    |
|                                      |             |                                              | $T_{vj} = 125\text{ °C}$ |        | 1.55 |      |      |
|                                      |             |                                              | $T_{vj} = 175\text{ °C}$ |        | 1.65 |      |      |
| Gate-emitter threshold voltage       | $V_{GETh}$  | $I_C = 0.75\text{ mA}$ , $V_{CE} = V_{GE}$   |                          | 3.2    | 4    | 4.8  | V    |

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表 3 (续) 特征值

| Parameter                           | Symbol       | Note or test condition                                                                                                                                                   |                                                               | Values |      |      | Unit          |
|-------------------------------------|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------|--------|------|------|---------------|
|                                     |              |                                                                                                                                                                          |                                                               | Min.   | Typ. | Max. |               |
| Zero gate-voltage collector current | $I_{CES}$    | $V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$                                                                                                                           | $T_{vj} = 25 \text{ }^{\circ}\text{C}$                        |        |      | 1900 | $\mu\text{A}$ |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 175 \text{ }^{\circ}\text{C}$                       |        | 3000 |      |               |
| Zero gate-voltage collector current | $I_{CES}$    | $V_{CE} = 480 \text{ V}, V_{GE} = 0 \text{ V}$                                                                                                                           | $T_{vj} = 25 \text{ }^{\circ}\text{C}$                        |        |      | 50   | $\mu\text{A}$ |
| Gate-emitter leakage current        | $I_{GES}$    | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$                                                                                                                            |                                                               |        |      | 100  | nA            |
| Transconductance                    | $g_{fs}$     | $I_C = 75 \text{ A}, V_{CE} = 20 \text{ V}$                                                                                                                              |                                                               |        | 100  |      | S             |
| Input capacitance                   | $C_{ies}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$                                                                                                       |                                                               |        | 4000 |      | pF            |
| Output capacitance                  | $C_{oes}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$                                                                                                       |                                                               |        | 785  |      | pF            |
| Reverse transfer capacitance        | $C_{res}$    | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 250 \text{ kHz}$                                                                                                       |                                                               |        | 15   |      | pF            |
| Gate charge                         | $Q_G$        | $I_C = 75 \text{ A}, V_{GE} = 15 \text{ V}, V_{CC} = 520 \text{ V}$                                                                                                      |                                                               |        | 164  |      | nC            |
| Turn-on delay time                  | $t_{d(on)}$  | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 5.6 \text{ } \Omega, R_{Goff} = 5.6 \text{ } \Omega, L_{\sigma} = 30 \text{ nH}, C_{\sigma} = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$    |        | 22   |      | ns            |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$  |        | 21   |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$   |        | 22   |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$ |        | 20   |      |               |
| Rise time (inductive load)          | $t_r$        | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 5.6 \text{ } \Omega, R_{Goff} = 5.6 \text{ } \Omega, L_{\sigma} = 30 \text{ nH}, C_{\sigma} = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$    |        | 13   |      | ns            |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$  |        | 8    |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$   |        | 15   |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$ |        | 8    |      |               |
| Turn-off delay time                 | $t_{d(off)}$ | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 5.6 \text{ } \Omega, R_{Goff} = 5.6 \text{ } \Omega, L_{\sigma} = 30 \text{ nH}, C_{\sigma} = 30 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$    |        | 145  |      | ns            |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 25 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$  |        | 155  |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 75 \text{ A}$   |        | 168  |      |               |
|                                     |              |                                                                                                                                                                          | $T_{vj} = 150 \text{ }^{\circ}\text{C}, I_C = 37.5 \text{ A}$ |        | 195  |      |               |

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**表 3** (续) 特征值

| Parameter                              | Symbol        | Note or test condition                                                                                                                                                   | Values                                                          |      |      | Unit             |
|----------------------------------------|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------|------|------|------------------|
|                                        |               |                                                                                                                                                                          | Min.                                                            | Typ. | Max. |                  |
| Fall time (inductive load)             | $t_f$         | $V_{CC} = 400\text{ V}$ , $V_{GE} = 0/15\text{ V}$ ,<br>$R_{Gon} = 5.6\ \Omega$ ,<br>$R_{Goff} = 5.6\ \Omega$ , $L_\sigma = 30\text{ nH}$ ,<br>$C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$    | 21   |      | ns               |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$  | 26   |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$   | 24   |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$ | 33   |      |                  |
| Turn-on energy                         | $E_{on}$      | $V_{CC} = 400\text{ V}$ , $V_{GE} = 0/15\text{ V}$ ,<br>$R_{Gon} = 5.6\ \Omega$ ,<br>$R_{Goff} = 5.6\ \Omega$ , $L_\sigma = 30\text{ nH}$ ,<br>$C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$    | 0.45 |      | mJ               |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$  | 0.2  |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$   | 0.57 |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$ | 0.25 |      |                  |
| Turn-off energy                        | $E_{off}$     | $V_{CC} = 400\text{ V}$ , $V_{GE} = 0/15\text{ V}$ ,<br>$R_{Gon} = 5.6\ \Omega$ ,<br>$R_{Goff} = 5.6\ \Omega$ , $L_\sigma = 30\text{ nH}$ ,<br>$C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$    | 0.75 |      | mJ               |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$  | 0.42 |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$   | 1.24 |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$ | 0.75 |      |                  |
| Total switching energy                 | $E_{ts}$      | $V_{CC} = 400\text{ V}$ , $V_{GE} = 0/15\text{ V}$ ,<br>$R_{Gon} = 5.6\ \Omega$ ,<br>$R_{Goff} = 5.6\ \Omega$ , $L_\sigma = 30\text{ nH}$ ,<br>$C_\sigma = 30\text{ pF}$ | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$    | 1.2  |      | mJ               |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 25\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$  | 0.62 |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 75\text{ A}$   | 1.81 |      |                  |
|                                        |               |                                                                                                                                                                          | $T_{vj} = 150\text{ }^\circ\text{C}$ ,<br>$I_C = 37.5\text{ A}$ | 1    |      |                  |
| IGBT thermal resistance, junction-case | $R_{th(j-c)}$ |                                                                                                                                                                          |                                                                 |      | 0.38 | K/W              |
| Operating junction temperature         | $T_{vj}$      |                                                                                                                                                                          | -40                                                             |      | 175  | $^\circ\text{C}$ |

### 3 二极管

**表4 最大额定值**

| Parameter                                                        | Symbol       | Note or test condition     |                       | Values | Unit |
|------------------------------------------------------------------|--------------|----------------------------|-----------------------|--------|------|
| Repetitive peak reverse voltage                                  | $V_{RRM}$    | $T_{vj} \geq 25\text{ °C}$ |                       | 650    | V    |
| Diode forward current, limited by $T_{vjmax}$                    | $I_F$        | limited by bondwire        | $T_c = 25\text{ °C}$  | 80     | A    |
|                                                                  |              |                            | $T_c = 100\text{ °C}$ | 57     |      |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$ <sup>1)</sup> | $I_{Fpulse}$ |                            |                       | 225    | A    |

1) 脉冲电流水平取决于二极管芯片的  $T_{vj}$ ，另见图“最大脉冲电流与结温的关系”

**表5 特征值**

| Parameter                               | Symbol        | Note or test condition |                          | Values |      |      | Unit |
|-----------------------------------------|---------------|------------------------|--------------------------|--------|------|------|------|
|                                         |               |                        |                          | Min.   | Typ. | Max. |      |
| Diode forward voltage                   | $V_F$         | $I_F = 60\text{ A}$    | $T_{vj} = 25\text{ °C}$  |        | 1.35 | 1.5  | V    |
|                                         |               |                        | $T_{vj} = 125\text{ °C}$ |        | 1.55 |      |      |
|                                         |               |                        | $T_{vj} = 175\text{ °C}$ |        | 1.65 |      |      |
| Diode thermal resistance, junction-case | $R_{th(j-c)}$ |                        |                          |        |      | 0.68 | K/W  |
| Operating junction temperature          | $T_{vj}$      |                        |                          | -40    |      | 175  | °C   |

注意：为了获得最佳的使用寿命和可靠性，英飞凌建议运行条件不超过本数据手册中所述最大额定值的80%。

除非另有规定，电气特性均为  $T_{vj} = 25\text{ °C}$ 。

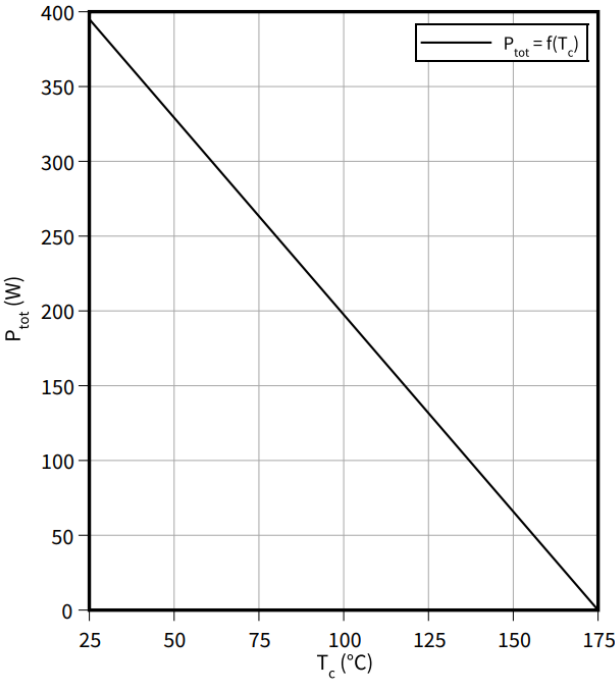
动态测试电路，寄生电感  $L_\sigma$ ，寄生电容  $C_\sigma$ ，来自图E。能量损失包括“拖尾”和二极管反向恢复。

4 特性图

4 特性图

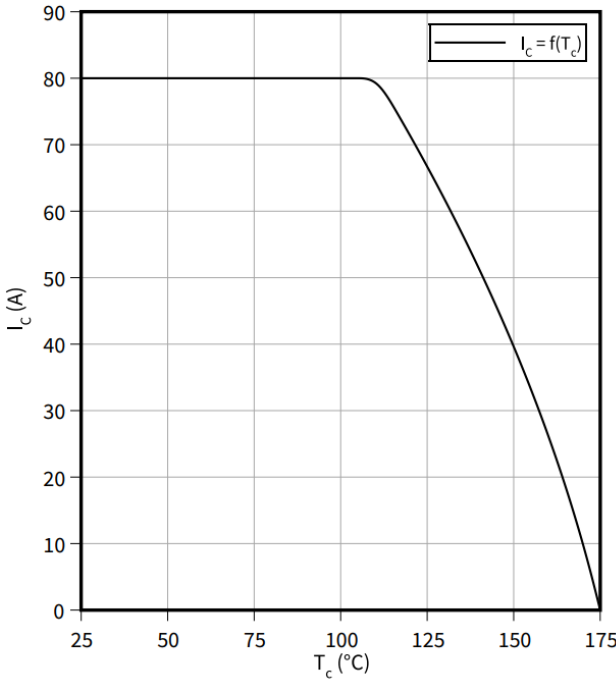
**Power dissipation as a function of case temperature**

$P_{\text{tot}} = f(T_c)$   
 $T_{vj} \leq 175\text{ }^{\circ}\text{C}$



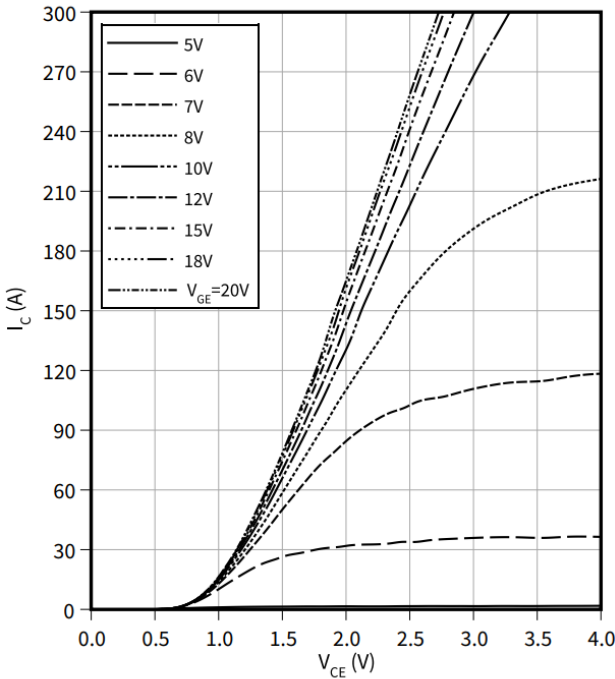
**Collector current as a function of case temperature**

$I_C = f(T_c)$   
 $T_{vj} \leq 175\text{ }^{\circ}\text{C}, V_{GE} \geq 15\text{ V}$



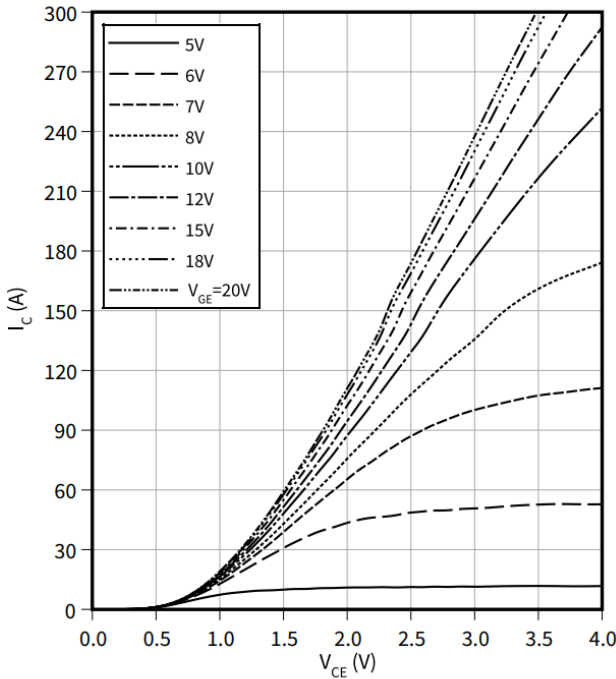
**Typical output characteristic**

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ }^{\circ}\text{C}$



**Typical output characteristic**

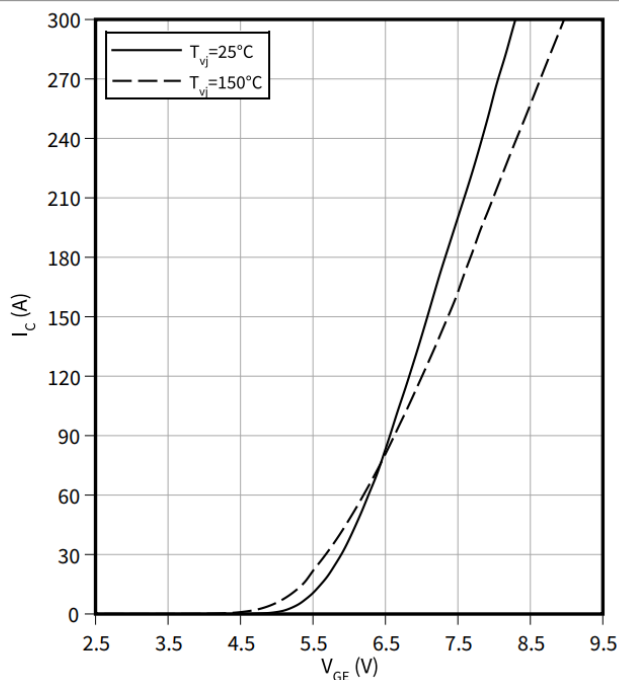
$I_C = f(V_{CE})$   
 $T_{vj} = 150\text{ }^{\circ}\text{C}$



4 特性图

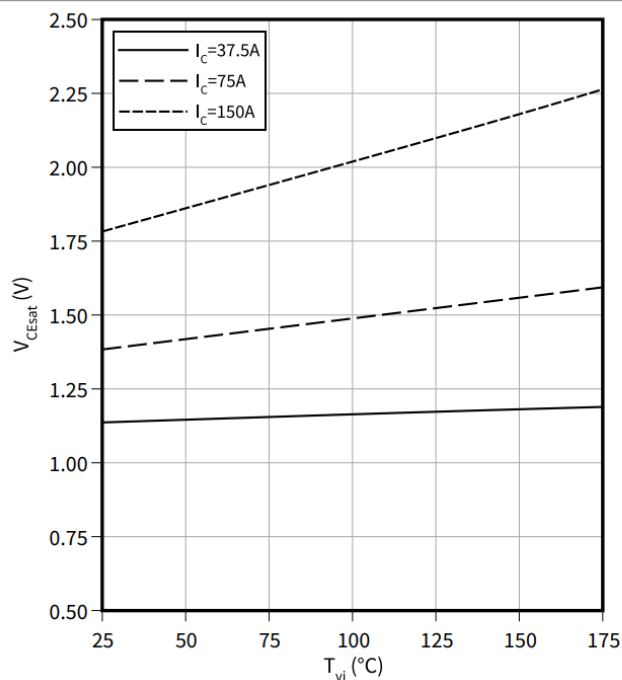
**Typical transfer characteristic**

$I_C = f(V_{GE})$   
 $V_{CE} = 20 \text{ V}$



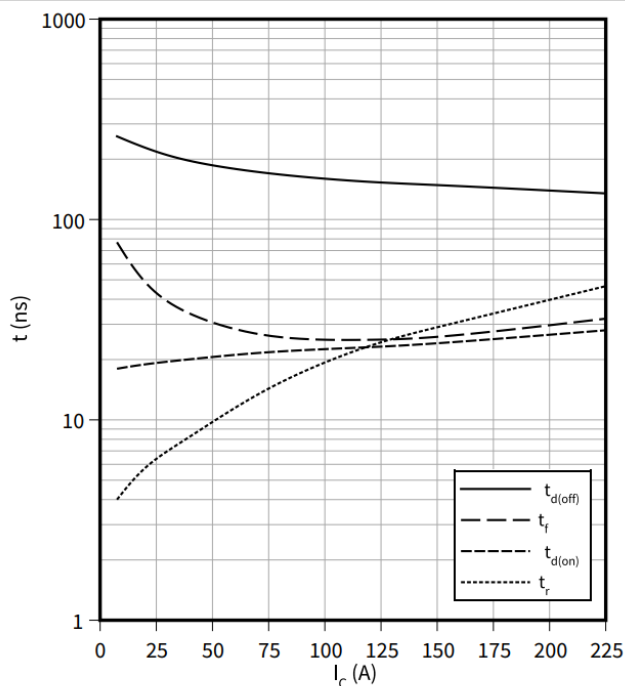
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15 \text{ V}$



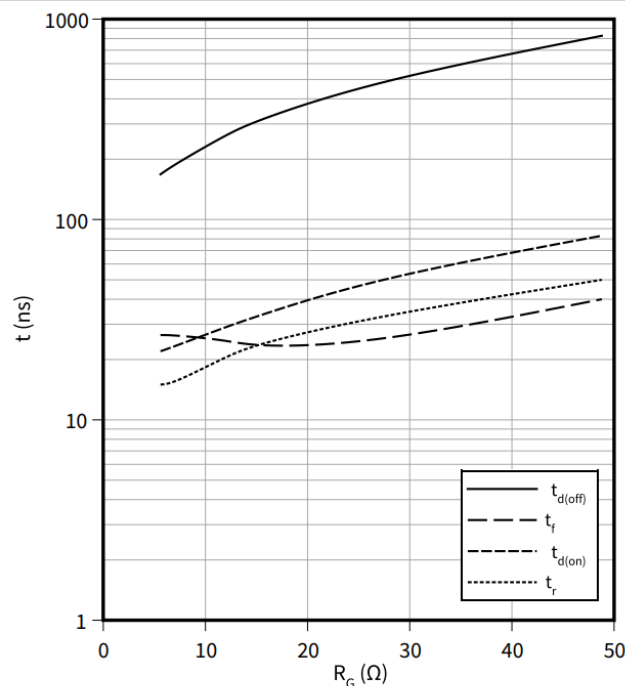
**Typical switching times as a function of collector current**

$t = f(I_C)$   
 $V_{CC} = 400 \text{ V}$ ,  $T_{vj} = 150^\circ\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 5.6 \Omega$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$   
 $I_C = 75 \text{ A}$ ,  $V_{CC} = 400 \text{ V}$ ,  $T_{vj} = 150^\circ\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$

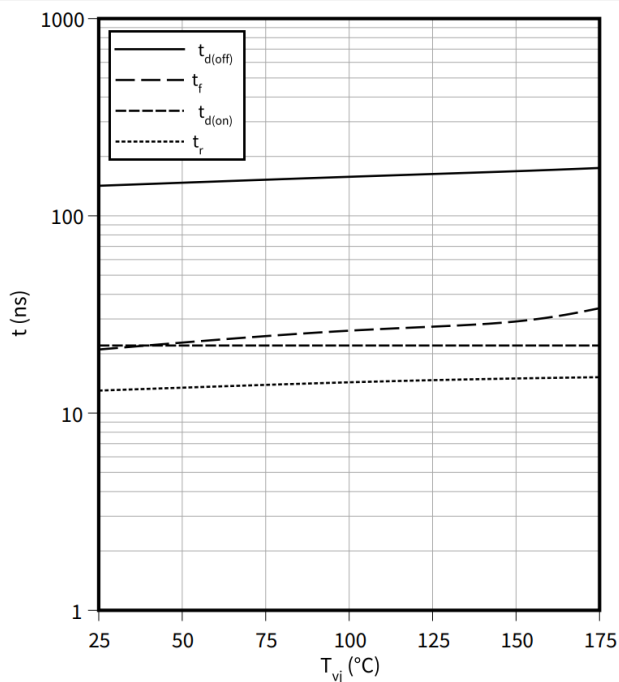


4 特性图

**Typical switching times as a function of junction temperature**

$$t = f(T_{vj})$$

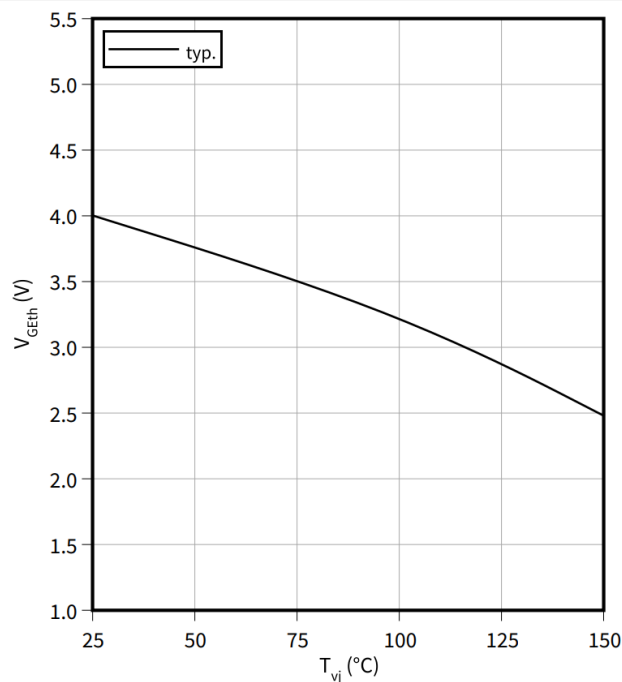
$I_C = 75\text{ A}$ ,  $V_{CC} = 400\text{ V}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 5.6\ \Omega$



**Gate-emitter threshold voltage as a function of junction temperature**

$$V_{GEth} = f(T_{vj})$$

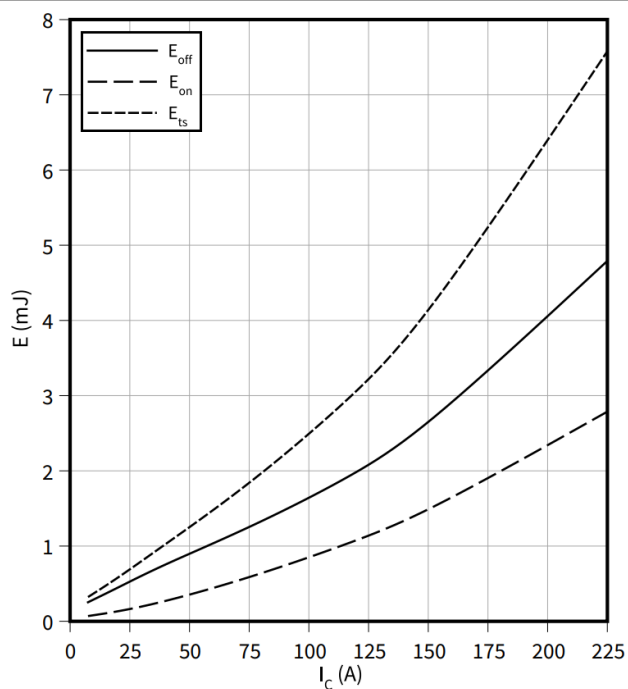
$I_C = 0.75\text{ mA}$



**Typical switching energy losses as a function of collector current**

$$E = f(I_C)$$

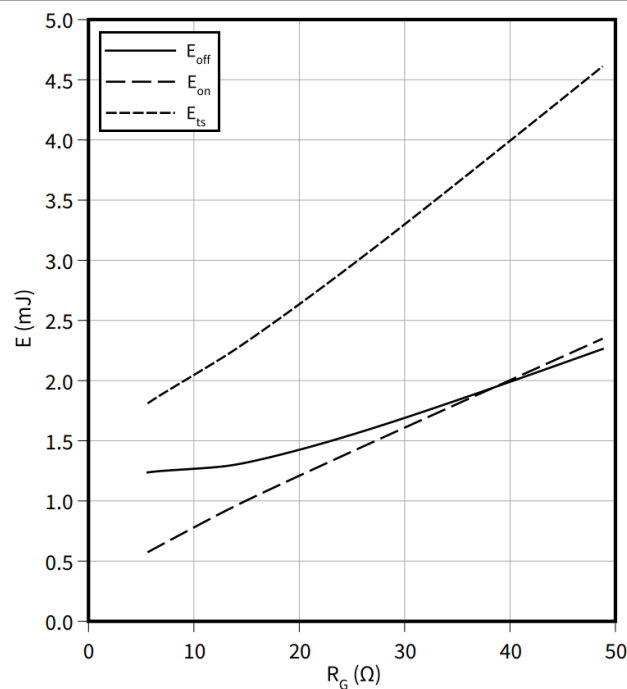
$V_{CC} = 400\text{ V}$ ,  $T_{vj} = 150\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 5.6\ \Omega$



**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$

$I_C = 75\text{ A}$ ,  $V_{CC} = 400\text{ V}$ ,  $T_{vj} = 150\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$

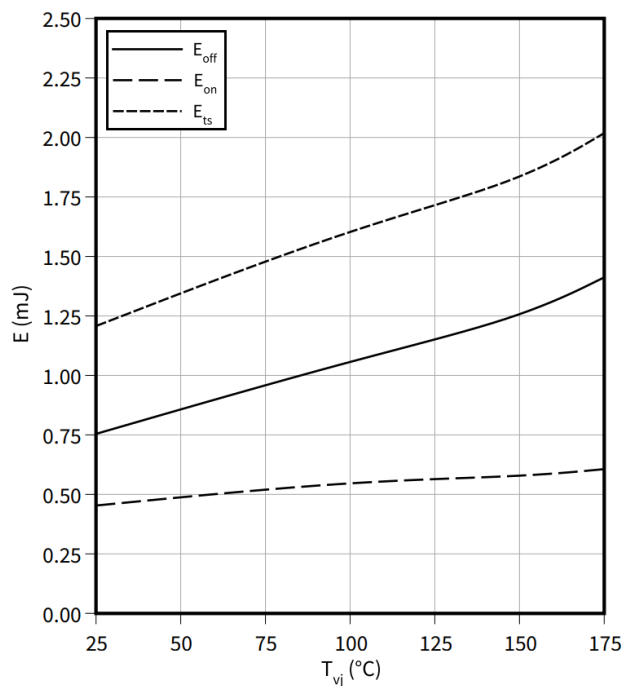


4 特性图

**Typical switching energy losses as a function of junction temperature**

$$E = f(T_{vj})$$

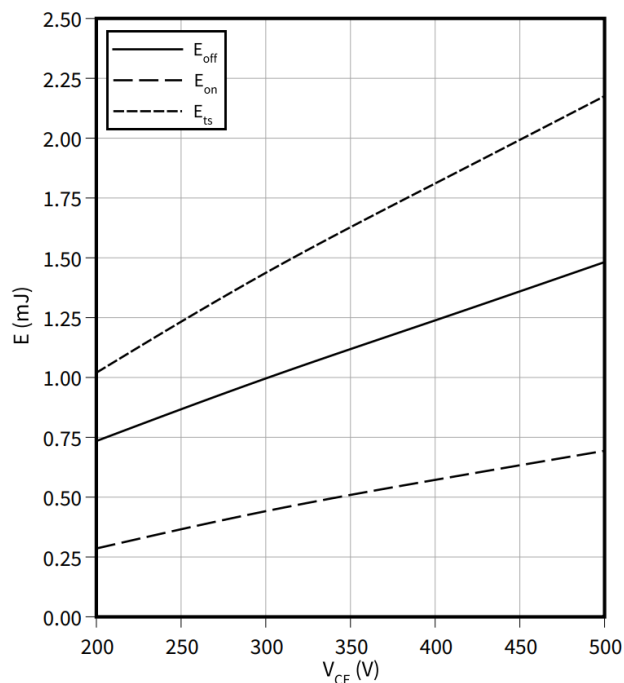
$I_C = 75 \text{ A}$ ,  $V_{CC} = 400 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 5.6 \Omega$



**Typical switching energy losses as a function of collector emitter voltage**

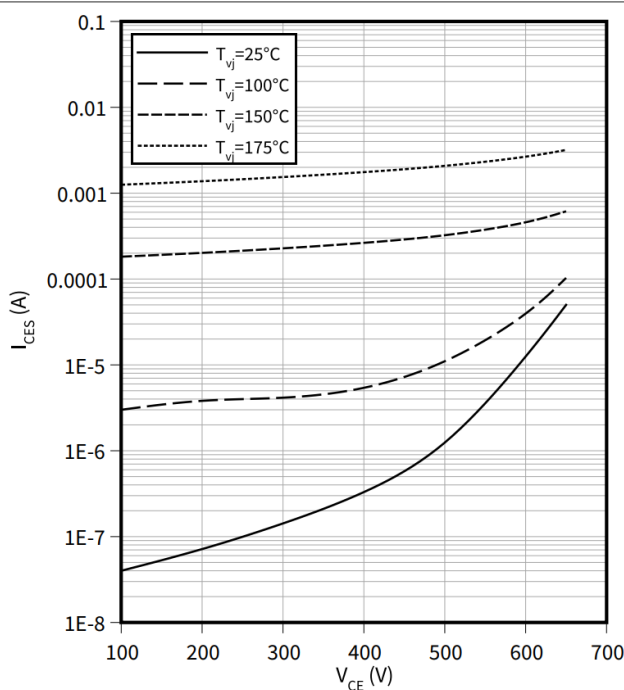
$$E = f(V_{CE})$$

$I_C = 75 \text{ A}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 5.6 \Omega$



**Typ. reverse current vs. reverse voltage as a function of Tvj**

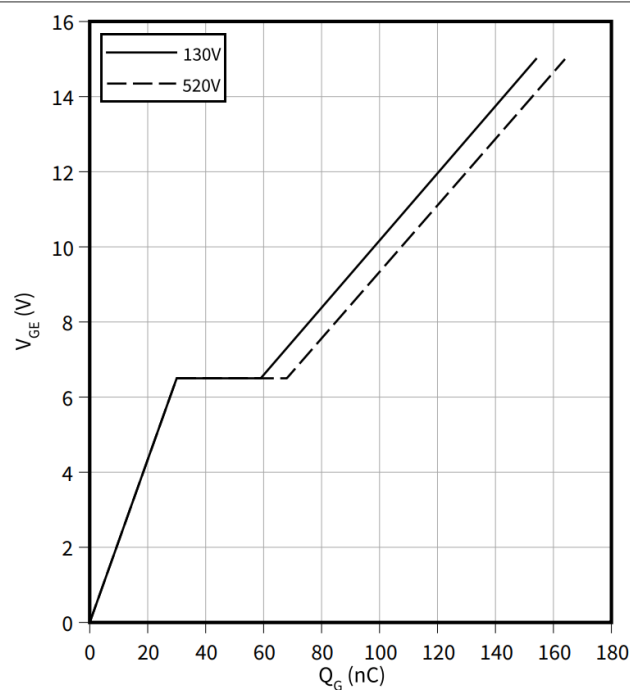
$$I_{CES} = f(V_{CE})$$



**Typical gate charge**

$$V_{GE} = f(Q_G)$$

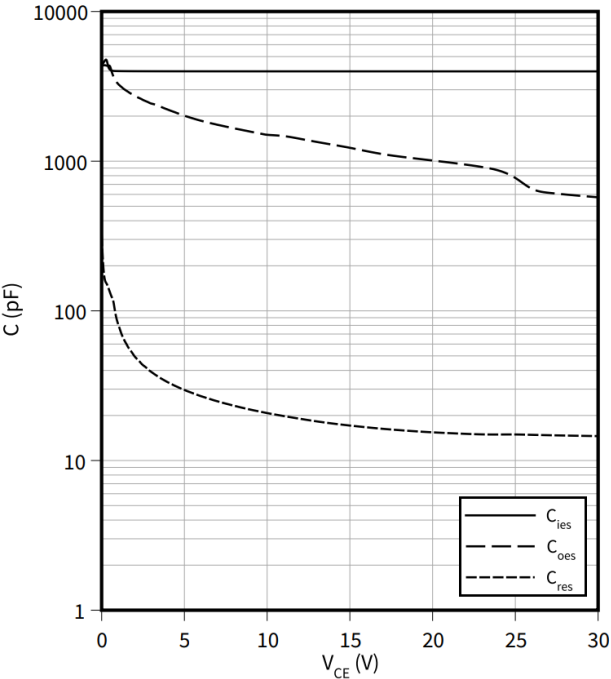
$I_C = 75 \text{ A}$



4 特性图

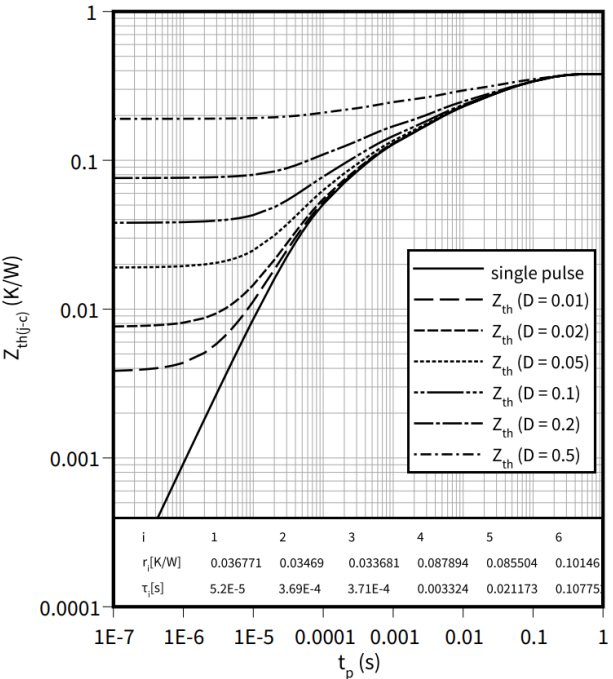
Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$   
 $f = 250\text{ kHz}, V_{GE} = 0\text{ V}$



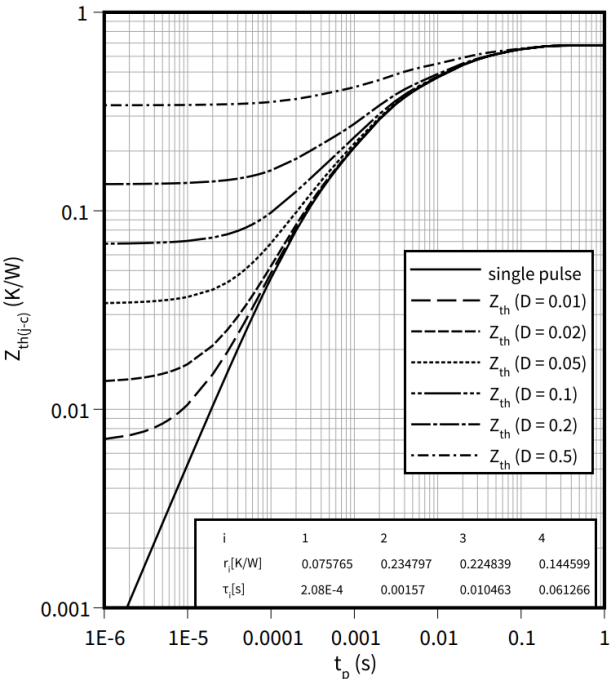
IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



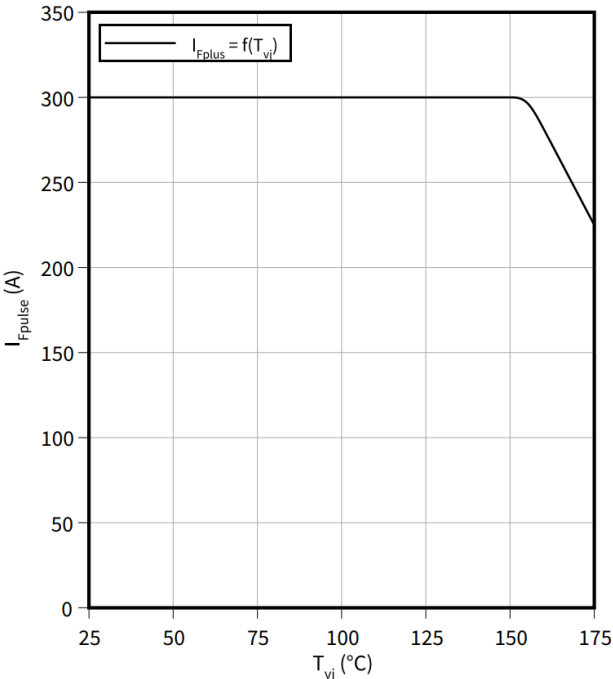
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



Maximum pulse current as a function of junction temperature

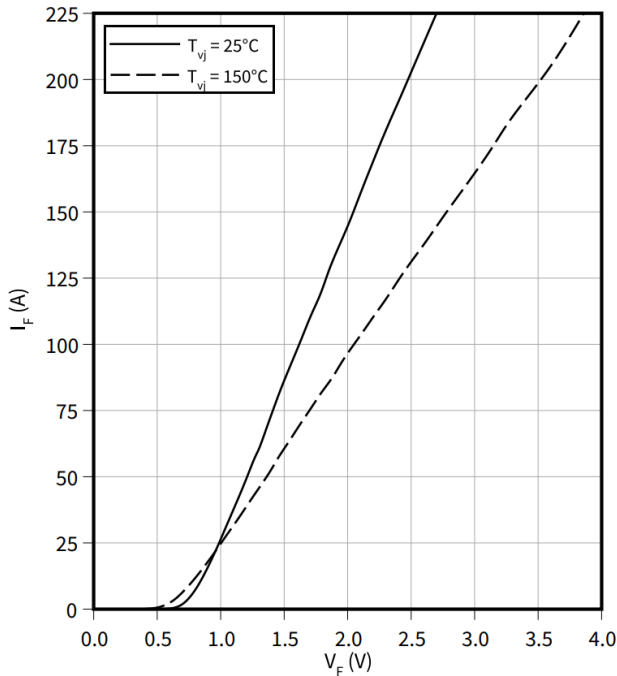
$I_{Fpulse} = f(T_{vj})$



4 特性图

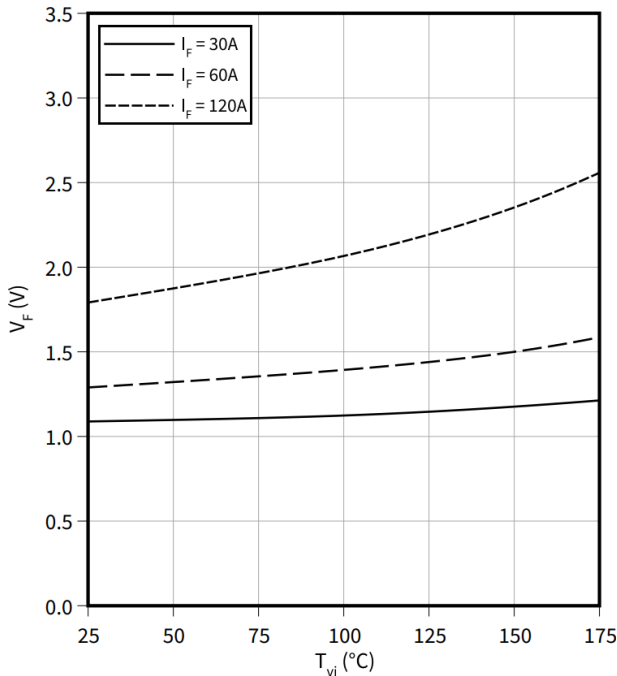
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$



5 封装外形

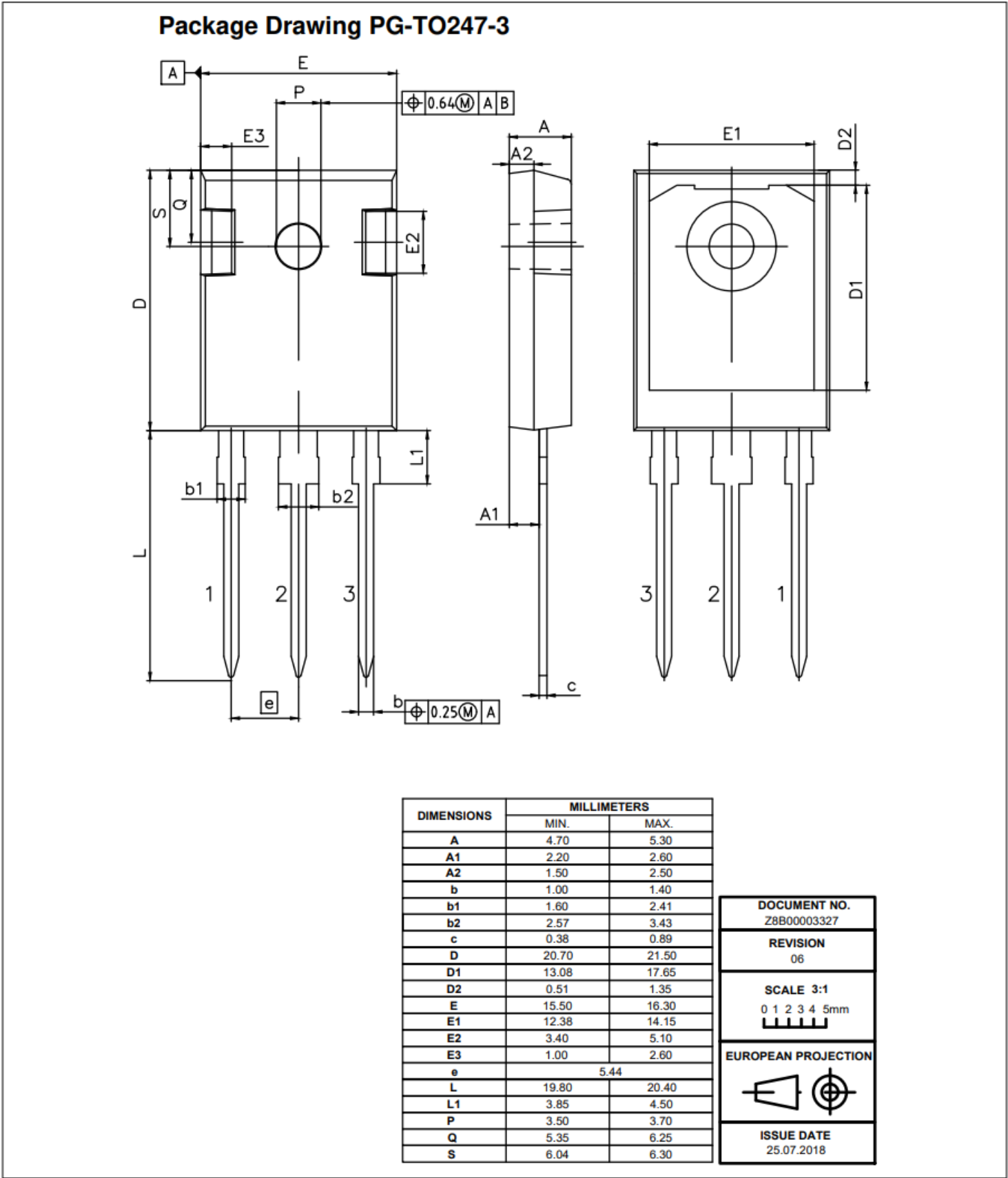


图 1

## 6 测试条件

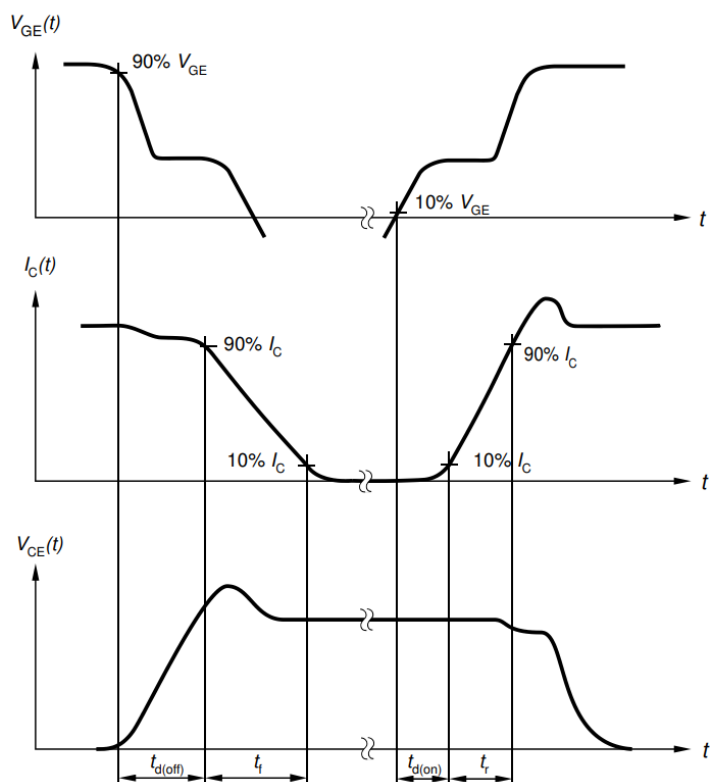


Figure A. Definition of switching times

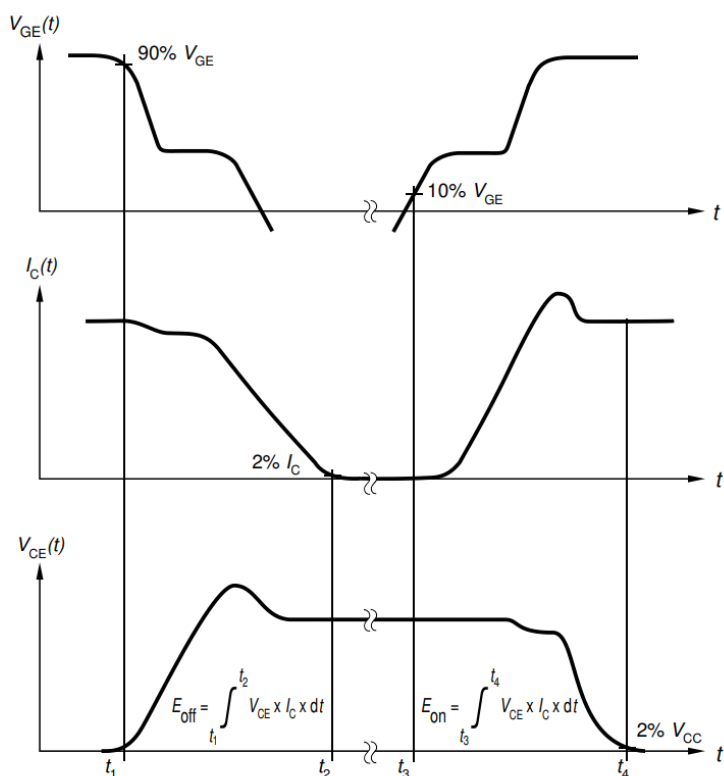


Figure B. Definition of switching losses

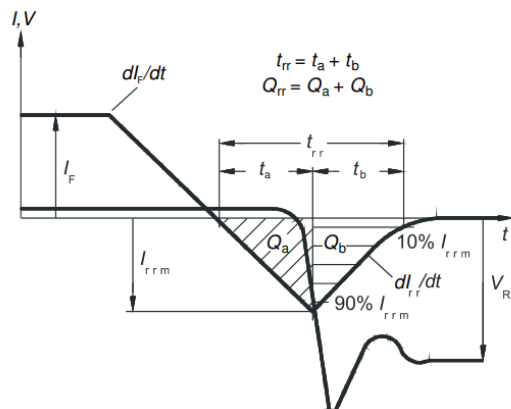


Figure C. Definition of diode switching characteristics

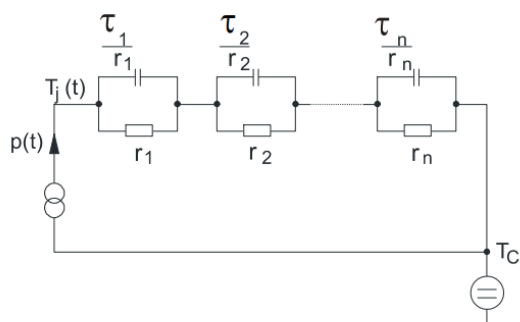


Figure D. Thermal equivalent circuit

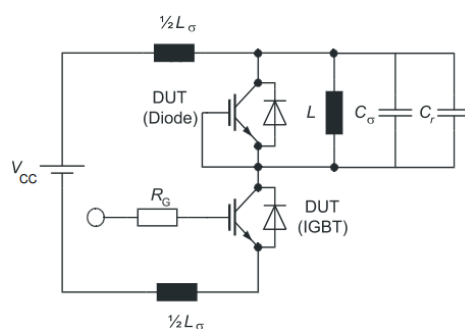


Figure E. **Dynamic test circuit**  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

## 修订记录

| Document revision | Date of release | Description of changes                                                                                                                              |
|-------------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|
| V1.1              | 2020-03-20      | Preliminary Data Sheet                                                                                                                              |
| V2.1              | 2020-07-27      | Final Data Sheet                                                                                                                                    |
| n/a               | 2020-11-30      | Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy |
| 1.10              | 2022-09-22      | Rename of product family name from “Hybrid CoolSiC™ IGBT” to “CoolSiC™ hybrid discrete”                                                             |



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版本 2025-09-16

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